

AOS Semiconductor Product Reliability Report

AOT2500L, rev A

Plastic Encapsulated Device

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This AOS product reliability report summarizes the qualification result for AOT2500L. Accelerated environmental tests are performed on a specific sample size, and then followed by electrical test at end point. Review of final electrical test result confirms that AOT2500L passes AOS quality and reliability requirements.

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I. Product Description:

The AOT2500L uses Trench MOSFET technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$, Ciss and Coss. This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.

- -RoHS Compliant
- -Halogen-Free

Details refer to the datasheet.

II. Die / Package Information:

AOT2500L

Process Standard sub-micron

150V N-Channel MOSFET

Package TypeTO220Lead FrameBare CuDie AttachSoft solderBondingAl wire

Mold Material Epoxy resin with silica filler

Moisture Level Up to Level 1



III. Result of Reliability Stress for AOT2500L

	Time Point	Lot Attribution	Total Sample size	Number of Failures	Reference Standard
168hr 85°c /85%RH +3 cycle reflow@260°c	-	12 lots	2541pcs	0	JESD22- A113
Temp = 150°c , Vgs=100% of Vgsmax	168hrs 500 hrs 1000 hrs	2 lots 6 lots	616pcs 77 pcs / lot	0	JESD22- A108
Temp = 150°c , Vds=80% of Vdsmax	168hrs 500 hrs 1000 hrs	2 lots 6 lots	616pcs 77 pcs / lot	0	JESD22- A108
130°c , 85%RH, 33.3 psi, Vds = 80% of Vdsmax	96 hrs	9 lots (Note A*)	693pcs 77 pcs / lot	0	JESD22- A110
121°c , 29.7psi, RH=100%	96 hrs	12 lots (Note A*)	924pcs 77 pcs / lot	0	JESD22- A102
-65°c to 150°c, air to air,	250 / 500 cycles	12 lots	924pcs	0	JESD22- A104
	/85%RH +3 cycle reflow@260°c Temp = 150°c , Vgs=100% of Vgsmax Temp = 150°c , Vds=80% of Vdsmax 130°c , 85%RH, 33.3 psi, Vds = 80% of Vdsmax 121°c , 29.7psi, RH=100%	168hr 85°c /85%RH +3 cycle reflow@260°c Temp = 150°c , Vgs=100% of Vgsmax Temp = 150°c , Vds=80% of Vdsmax 130°c , 85%RH, 33.3 psi, Vds = 80% of Vdsmax 121°c , 29.7psi, RH=100% -65°c to 150°c , 250 / 500	168hr 85°C /85%RH +3 cycle reflow@260°C Temp = 150°C, Vgs=100% of Vgsmax Temp = 150°C, Vds=80% of Vdsmax 1000 hrs 168hrs 500 hrs 500 hrs 1000 hrs 2 lots 168hrs 500 hrs 2 lots 168hrs 500 hrs 9 lots 130°C, 85%RH, 33.3 psi, Vds = 80% of Vdsmax 121°C, 29.7psi, RH=100% (Note A*) -65°C to 150°C, 250 / 500 12 lots	168hr 85°c /85%RH +3 cycle reflow@260°c Temp = 150°c , Vgs=100% of Vgsmax Temp = 150°c , Vds=80% of Vdsmax 168hrs 500 hrs 1000 hrs 6 lots 77 pcs / lot 168hrs 500 hrs 1000 hrs 6 lots 77 pcs / lot 130°c , 85%RH, 33.3 psi, Vds = 80% of Vdsmax (Note A*) 12 lots 77 pcs / lot	Tailures

Note A: The reliability data presents total of available generic data up to the published date.

IV. Reliability Evaluation

FIT rate (per billion): 3.27 MTTF = 34906 years

The presentation of FIT rate for the individual product reliability is restricted by the actual burn-in sample size of the selected product (AOT2500L). Failure Rate Determination is based on JEDEC Standard JESD 85. FIT means one failure per billion hours.

Failure Rate (FIT) =
$$\text{Chi}^2 \times 10^9 / [2 \text{ (N) (H) (Af)}]$$

= $1.83 \times 10^9 / [2x (4x77x500 + 12x77x1000) x259] = 3.27$
MTTF = $10^9 / \text{FIT} = 3.06 \times 10^8 \text{hrs} = 34906 \text{ years}$

Chi² = Chi Squared Distribution, determined by the number of failures and confidence interval

N = Total Number of units from HTRB and HTGB tests

H = Duration of HTRB/HTGB testing

Af = Acceleration Factor from Test to Use Conditions (Ea = 0.7eV and Tuse = 55°C)

Acceleration Factor [Af] = Exp [Ea / k (1/Tj u - 1/Tj s)]

Acceleration Factor ratio list:

	55 deg C	70 deg C	85 deg C	100 deg C	115 deg C	130 deg C	150 deg C
Af	259	87	32	13	5.64	2.59	1

Tj s = Stressed junction temperature in degree (Kelvin), K = C+273.16

Tj u = The use junction temperature in degree (Kelvin), K = C+273.16

 \mathbf{k} = Boltzmann's constant, 8.617164 x 10⁻⁵eV / K